

ACCU-LABS INC.

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A2LA Accredited ISO/IEC 17025:2005 Certificate # 2558.01

944

TIN/LEAD STRIPPER

ACCU-LABS 944 was specifically developed as a fast, efficient, safe and convenient method for removing tin and tin/lead (solder) from finished printed circuit boards and other copper or copper alloy parts.

ACCU-LABS 944 was formulated so that attack upon the copper base is non-existent. **944** will not attack or alter a properly cured resin based board or copper parts. It is unique in that it produces no passivation of the copper undercoating, eliminating the use of bright dips after stripping. The stripping rate of fresh **ACCU-LABS 944** is approximately 6 mils per hour at room temperature.

COMPOSITION: **944** is a balanced blend of strong acids, oxidants, and surface active agents.

OPERATING GUIDELINES:

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|-------------------|---|
| Concentration: | Use as is at full strength |
| Time: | 6 mils per hour with fresh bath |
| Temperature: | Ambient |
| Equipment: | Polyethylene, polypropylene, rubber or Koroseal lined tank. |
| Baskets or Racks: | Plastisol covered steel. |

CAUTION:

ACCU-LABS 944 is a blend of strong acids, oxidants, and inhibitors and should be stored in a cool place away from any organic solvents. Rubber gloves, protective raiment, and goggles should be worn when handling. Read the Material Safety Data Sheet before working with this product.

DISCLAIMER:

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